DECLARAI	ION FOR PAIR	ENT APPLICATION	Docket Number (Optional)
	·	•	MR1957-815
As a below named inventor, I hereby declare that:			
My residence, post office address and citizenship are as stated below next to my name.			
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SEMICONDUCTOR DEVICE BY EMBEDDED PACKAGE , the specification of which is attached basely upleas the following box is should be attached basely upleas the following box is should be attached by the specification of the specificatio			
and v	was amended on	(іт а	pplicable).
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56.  I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.  Prior Foreign Application(s)			
(Co	ountry)	(Day/Month/Year Filed)	
	ountry)	(Day/Month/Year Filed)	
•	• ,	, ,	isted below.
	(Filing Date	· · · · · · · · · · · · · · · · · · ·	
is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.			
	(Filing Date	(Status-p	atented, pending, abandoned)
ted therewith: Mon Lee, Esq., #40 410-465-6678 Rosenberg, F 3458 Ellicot	gent(s) to prosecute rton J. Rosent 0,262; Harry I 8 Klein & Lee tt Center Driv	this application and to transacers, Esq., #26,049; Sernaker, Esq., #	David I. Klein, Esq
true; and further that ishable by fine or imperents may jeopard to (given name, fan	these statements worksonment, or both, ize the validity of the nily name) CHARNG (A.S. RD., TAIPEI, ame, family name)	ere made with the knowledge under Section 1001 of Title 1 e application or any patent iss SENG SHEEN (FAMILY, NAME:  Date	that willful false statements 8 of the United States Code ued thereon. SHEEN)
	I hereby declare that dress and citizenship st and sole inventor (ne subject matter white subject matter white EMBEDDED PACKAGE ass the following box and viewed and understant referred to above. Sclose information white benefits under 35 365(a) of any PCT Ind have also identified all application having (Conted States, listed benefits detect therewith: Montate of the prior application whate of the prior application who was a state of the prior	I hereby declare that:  dress and citizenship are as stated below st and sole inventor (if only one name is the subject matter which is claimed and for EMBEDDED PACKAGE.  as United States A and was amended on and was amend	I hereby declare that:  dress and citizenship are as stated below next to my name.  st and sole inventor (if only one name is listed below) or an original, fir the subject matter which is claimed and for which a patent is sought on EMEDDED PACKAGE.  as United States Application Number or PCT Interpretation and was amended on

 $\hfill \Box$  Additional Inventors are being named on separately numbered sheets attached hereto.